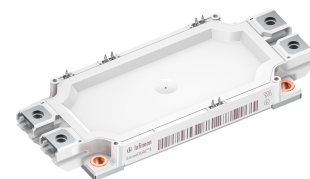


## Final datasheet

### EconoDUAL™3 module with CoolSiC™ Trench MOSFET and PressFIT / NTC

#### Features

- Electrical features
  - $V_{DS} = 1200\text{ V}$
  - $I_{DN} = 500\text{ A}$  /  $I_{DRM} = 1000\text{ A}$
  - Integrated temperature sensor
  - Suitable Infineon gate drivers can be found under <https://www.infineon.com/gdfinder>
- Mechanical features
  - Standard housing
  - PressFIT contact technology
  - Isolated base plate
  - High power density
  - Direct-cooled base plate



#### Potential applications

- Construction, commercial, and agriculture vehicles
- Wind turbines
- Motor drives
- UPS systems
- Solar applications

#### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

#### Description

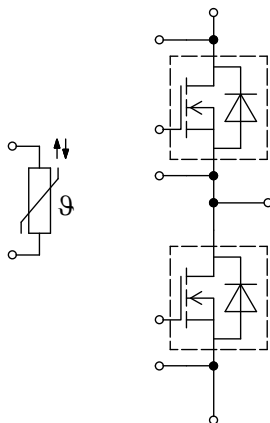


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## 1 Package

**Table 1**                      **Insulation coordination**

| Parameter                           | Symbol                  | Note or test condition                         | Values    | Unit |
|-------------------------------------|-------------------------|------------------------------------------------|-----------|------|
| Isolation test voltage              | $V_{ISOL}$              | RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min}$ | 3.4       | kV   |
| Isolation test voltage NTC          | $V_{ISOL(NTC)}$         | RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min}$ | 3.4       | kV   |
| Material of module baseplate        |                         |                                                | Cu        |      |
| Internal isolation                  |                         | basic insulation (class 1, IEC 61140)          | $Al_2O_3$ |      |
| Creepage distance                   | $d_{Creep \text{ nom}}$ | terminal to baseplate, nom.                    | > 15      | mm   |
| Creepage distance                   | $d_{Creep \text{ min}}$ | terminal to baseplate, min.                    | 14.7      | mm   |
| Creepage distance                   | $d_{Creep \text{ nom}}$ | terminal to terminal, nom.                     | > 19.3    | mm   |
| Creepage distance                   | $d_{Creep \text{ min}}$ | terminal to terminal, min.                     | 19.3      | mm   |
| Clearance                           | $d_{Clear \text{ nom}}$ | terminal to baseplate, nom.                    | > 12.5    | mm   |
| Clearance                           | $d_{Clear \text{ min}}$ | terminal to baseplate, min.                    | 12.5      | mm   |
| Clearance                           | $d_{Clear \text{ nom}}$ | terminal to terminal, nom.                     | > 10      | mm   |
| Clearance                           | $d_{Clear \text{ min}}$ | terminal to terminal, min.                     | 9.6       | mm   |
| Comparative tracking index          | $CTI$                   |                                                | > 200     |      |
| Relative thermal index (electrical) | $RTI$                   | housing                                        | 140       | °C   |

**Table 2**                      **Characteristic values**

| Parameter                                | Symbol        | Note or test condition                                                                                        | Values |      |      | Unit |
|------------------------------------------|---------------|---------------------------------------------------------------------------------------------------------------|--------|------|------|------|
|                                          |               |                                                                                                               | Min.   | Typ. | Max. |      |
| Pressure drop in cooling circuit         | $\Delta p$    | $\Delta V / \Delta t = 10.0 \text{ dm}^3 / \text{min}$ , 50% water / 50% ethylenglycol, $T_F = 60 \text{ °C}$ |        | 65   |      | mbar |
| Maximum pressure in cooling circuit      | $p$           |                                                                                                               |        |      | 3    | bar  |
| Stray inductance module                  | $L_{sCE}$     |                                                                                                               |        | 20   |      | nH   |
| Module lead resistance, terminals - chip | $R_{CC'+EE'}$ | $T_F = 25 \text{ °C}$ , per switch                                                                            |        | 0.8  |      | mΩ   |
| Storage temperature                      | $T_{stg}$     |                                                                                                               | -40    |      | 125  | °C   |
| Mounting torque for module mounting      | $M$           | - Mounting according to valid application note                                                                | 3      |      | 6    | Nm   |
| Terminal connection torque               | $M$           | - Mounting according to valid application note                                                                | 3      |      | 6    | Nm   |
| Weight                                   | $G$           |                                                                                                               |        | 345  |      | g    |

## 2 MOSFET, T1 / T2

**Table 3** Maximum rated values

| Parameter                                   | Symbol    | Note or test condition                            |                         | Values | Unit |
|---------------------------------------------|-----------|---------------------------------------------------|-------------------------|--------|------|
| Drain-source voltage                        | $V_{DS}$  |                                                   | $T_{vj} = 25\text{ °C}$ | 1200   | V    |
| Continuous DC drain current                 | $I_{DDC}$ | $T_{vj} = 175\text{ °C}$ , $V_{GS} = 18\text{ V}$ | $T_F = 50\text{ °C}$    | 500    | A    |
| Repetitive peak drain current               | $I_{DRM}$ | verified by design, $t_p$ limited by $T_{vjmax}$  |                         | 1000   | A    |
| Gate-source voltage, max. transient voltage | $V_{GS}$  | $D < 0.01$                                        |                         | -10/23 | V    |
| Gate-source voltage, max. static voltage    | $V_{GS}$  |                                                   |                         | -7/20  | V    |

**Table 4** Recommended values

| Parameter              | Symbol        | Note or test condition | Values  | Unit |
|------------------------|---------------|------------------------|---------|------|
| On-state gate voltage  | $V_{GS(on)}$  |                        | 15...18 | V    |
| Off-state gate voltage | $V_{GS(off)}$ |                        | -5...0  | V    |

**Table 5** Characteristic values

| Parameter                    | Symbol       | Note or test condition                                                                                                     |                                                      | Values |       |      | Unit |
|------------------------------|--------------|----------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------|--------|-------|------|------|
|                              |              |                                                                                                                            |                                                      | Min.   | Typ.  | Max. |      |
| Drain-source on-resistance   | $R_{DS(on)}$ | $I_D = 500\text{ A}$                                                                                                       | $V_{GS} = 15\text{ V}$ ,<br>$T_{vj} = 25\text{ °C}$  |        | 1.75  |      | mΩ   |
|                              |              |                                                                                                                            | $V_{GS} = 18\text{ V}$ ,<br>$T_{vj} = 25\text{ °C}$  |        | 1.46  | 1.91 |      |
|                              |              |                                                                                                                            | $V_{GS} = 18\text{ V}$ ,<br>$T_{vj} = 125\text{ °C}$ |        | 2.36  |      |      |
|                              |              |                                                                                                                            | $V_{GS} = 18\text{ V}$ ,<br>$T_{vj} = 175\text{ °C}$ |        | 3.13  |      |      |
| Gate threshold voltage       | $V_{GS(th)}$ | $I_D = 224\text{ mA}$ , $V_{DS} = V_{GS}$ , $T_{vj} = 25\text{ °C}$ , (tested after 1ms pulse at $V_{GS} = +20\text{ V}$ ) |                                                      | 3.45   | 4.3   | 5.15 | V    |
| Total gate charge            | $Q_G$        | $V_{DD} = 800\text{ V}$ , $V_{GS} = -3/18\text{ V}$ , $T_{vj} = 25\text{ °C}$                                              |                                                      |        | 1.6   |      | μC   |
| Internal gate resistor       | $R_{Gint}$   | $T_{vj} = 25\text{ °C}$                                                                                                    |                                                      |        | 0.9   |      | Ω    |
| Input capacitance            | $C_{ISS}$    | $f = 100\text{ kHz}$ , $V_{DS} = 800\text{ V}$ ,<br>$V_{GS} = 0\text{ V}$                                                  | $T_{vj} = 25\text{ °C}$                              |        | 48.4  |      | nF   |
| Output capacitance           | $C_{OSS}$    | $f = 100\text{ kHz}$ , $V_{DS} = 800\text{ V}$ ,<br>$V_{GS} = 0\text{ V}$                                                  | $T_{vj} = 25\text{ °C}$                              |        | 2.4   |      | nF   |
| Reverse transfer capacitance | $C_{rss}$    | $f = 100\text{ kHz}$ , $V_{DS} = 800\text{ V}$ ,<br>$V_{GS} = 0\text{ V}$                                                  | $T_{vj} = 25\text{ °C}$                              |        | 0.158 |      | nF   |
| $C_{OSS}$ stored energy      | $E_{OSS}$    | $V_{DS} = 800\text{ V}$ , $V_{GS} = -3/18\text{ V}$ , $T_{vj} = 25\text{ °C}$                                              |                                                      |        | 945   |      | μJ   |

(table continues...)

**Table 5** (continued) Characteristic values

| Parameter                                                   | Symbol             | Note or test condition                                                                                                                                                                                                                          |                          | Values |      |      | Unit               |
|-------------------------------------------------------------|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|--------|------|------|--------------------|
|                                                             |                    |                                                                                                                                                                                                                                                 |                          | Min.   | Typ. | Max. |                    |
| Drain-source leakage current                                | $I_{DSS}$          | $V_{DS} = 1200\text{ V}$ , $V_{GS} = -3\text{ V}$                                                                                                                                                                                               | $T_{vj} = 25\text{ °C}$  |        | 0.32 | 660  | $\mu\text{A}$      |
| Gate-source leakage current                                 | $I_{GSS}$          | $V_{DS} = 0\text{ V}$ , $T_{vj} = 25\text{ °C}$                                                                                                                                                                                                 | $V_{GS} = 20\text{ V}$   |        |      | 400  | nA                 |
| Turn-on delay time (inductive load)                         | $t_{d\text{ on}}$  | $I_D = 500\text{ A}$ , $R_{Gon} = 6.8\text{ }\Omega$ ,<br>$V_{DD} = 600\text{ V}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$t_{dead} = 1000\text{ ns}$                                                                                                  | $T_{vj} = 25\text{ °C}$  |        | 156  |      | ns                 |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 125\text{ °C}$ |        | 172  |      |                    |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 175\text{ °C}$ |        | 182  |      |                    |
| Rise time (inductive load)                                  | $t_r$              | $I_D = 500\text{ A}$ , $R_{Gon} = 6.8\text{ }\Omega$ ,<br>$V_{DD} = 600\text{ V}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$t_{dead} = 1000\text{ ns}$                                                                                                  | $T_{vj} = 25\text{ °C}$  |        | 261  |      | ns                 |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 125\text{ °C}$ |        | 243  |      |                    |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 175\text{ °C}$ |        | 238  |      |                    |
| Turn-off delay time (inductive load)                        | $t_{d\text{ off}}$ | $I_D = 500\text{ A}$ , $R_{Goff} = 3.9\text{ }\Omega$ ,<br>$V_{DD} = 600\text{ V}$ , $V_{GS} = -3/18\text{ V}$                                                                                                                                  | $T_{vj} = 25\text{ °C}$  |        | 276  |      | ns                 |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 125\text{ °C}$ |        | 305  |      |                    |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 175\text{ °C}$ |        | 319  |      |                    |
| Fall time (inductive load)                                  | $t_f$              | $I_D = 500\text{ A}$ , $R_{Goff} = 3.9\text{ }\Omega$ ,<br>$V_{DD} = 600\text{ V}$ , $V_{GS} = -3/18\text{ V}$                                                                                                                                  | $T_{vj} = 25\text{ °C}$  |        | 74   |      | ns                 |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 125\text{ °C}$ |        | 76   |      |                    |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 175\text{ °C}$ |        | 77   |      |                    |
| Turn-on energy loss per pulse                               | $E_{on}$           | $I_D = 500\text{ A}$ , $V_{DD} = 600\text{ V}$ ,<br>$L_\sigma = 8\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Gon} = 6.8\text{ }\Omega$ , $di/dt = 4.7\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ ),<br>$t_{dead} = 1000\text{ ns}$  | $T_{vj} = 25\text{ °C}$  |        | 40.2 |      | mJ                 |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 125\text{ °C}$ |        | 38.3 |      |                    |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 175\text{ °C}$ |        | 39   |      |                    |
| Turn-on energy loss per pulse, optimized                    | $E_{on,o}$         | $I_D = 500\text{ A}$ , $V_{DD} = 600\text{ V}$ ,<br>$L_\sigma = 8\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Gon,o} = 2.4\text{ }\Omega$ , $di/dt = 9.3\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ ),<br>$t_{dead} = 200\text{ ns}$ | $T_{vj} = 25\text{ °C}$  |        | 16.8 |      | mJ                 |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 125\text{ °C}$ |        | 17.1 |      |                    |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 175\text{ °C}$ |        | 18.1 |      |                    |
| Turn-off energy loss per pulse                              | $E_{off}$          | $I_D = 500\text{ A}$ , $V_{DD} = 600\text{ V}$ ,<br>$L_\sigma = 8\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Goff} = 3.9\text{ }\Omega$ , $dv/dt = 6.2\text{ kV}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ )                                 | $T_{vj} = 25\text{ °C}$  |        | 20.4 |      | mJ                 |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 125\text{ °C}$ |        | 21.6 |      |                    |
|                                                             |                    |                                                                                                                                                                                                                                                 | $T_{vj} = 175\text{ °C}$ |        | 22.2 |      |                    |
| Thermal resistance, junction to cooling fluid <sup>1)</sup> | $R_{thJF}$         | per MOSFET, $\Delta V/\Delta t = 10.0\text{ dm}^3/\text{min}$ , cooling fluid = 50% water / 50% ethylenglycol, $T_F = 60\text{ °C}$                                                                                                             |                          |        | 0.12 |      | K/W                |
| Temperature under switching conditions                      | $T_{vj\text{ op}}$ |                                                                                                                                                                                                                                                 |                          | -40    |      | 175  | $^{\circ}\text{C}$ |

1) Typical  $R_{thJF}$  value using the heat sink described in AN-2022-05

**Note:** The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Notes AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

$T_{vj\ op} > 150^\circ\text{C}$  is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13.

### 3 Body diode (MOSFET, T1 / T2)

**Table 6** Maximum rated values

| Parameter                     | Symbol   | Note or test condition                                                            | Values | Unit |
|-------------------------------|----------|-----------------------------------------------------------------------------------|--------|------|
| DC body diode forward current | $I_{SD}$ | $T_{vj} = 175^\circ\text{C}$ , $V_{GS} = -3\text{ V}$<br>$T_F = 25^\circ\text{C}$ | 295    | A    |

**Table 7** Characteristic values

| Parameter                          | Symbol      | Note or test condition                                                                                                                                                           | Values                       |      |      | Unit          |
|------------------------------------|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|------|------|---------------|
|                                    |             |                                                                                                                                                                                  | Min.                         | Typ. | Max. |               |
| Forward voltage                    | $V_{SD}$    | $I_{SD} = 500\text{ A}$ , $V_{GS} = -3\text{ V}$                                                                                                                                 | $T_{vj} = 25^\circ\text{C}$  | 4.14 | 5.2  | V             |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 125^\circ\text{C}$ | 3.88 |      |               |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 175^\circ\text{C}$ | 3.78 |      |               |
| Peak reverse recovery current      | $I_{rrm}$   | $I_{SD} = 500\text{ A}$ , $di_s/dt = 4.7\text{ kA}/\mu\text{s}$ , $V_{DD} = 600\text{ V}$ , $V_{GS} = -3\text{ V}$ , $t_{dead} = 1000\text{ ns}$                                 | $T_{vj} = 25^\circ\text{C}$  | 76   |      | A             |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 125^\circ\text{C}$ | 114  |      |               |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 175^\circ\text{C}$ | 148  |      |               |
| Recovered charge                   | $Q_{rr}$    | $I_{SD} = 500\text{ A}$ , $di_s/dt = 4.7\text{ kA}/\mu\text{s}$ , $V_{DD} = 600\text{ V}$ , $V_{GS} = -3\text{ V}$ , $t_{dead} = 1000\text{ ns}$                                 | $T_{vj} = 25^\circ\text{C}$  | 3.7  |      | $\mu\text{C}$ |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 125^\circ\text{C}$ | 4.9  |      |               |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 175^\circ\text{C}$ | 7    |      |               |
| Reverse recovery energy            | $E_{rec}$   | $I_{SD} = 500\text{ A}$ , $di_s/dt = 4.7\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175^\circ\text{C}$ ), $V_{DD} = 600\text{ V}$ , $V_{GS} = -3\text{ V}$ , $t_{dead} = 1000\text{ ns}$ | $T_{vj} = 25^\circ\text{C}$  | 0.12 |      | mJ            |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 125^\circ\text{C}$ | 0.37 |      |               |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 175^\circ\text{C}$ | 0.67 |      |               |
| Reverse recovery energy, optimized | $E_{rec,0}$ | $I_{SD} = 500\text{ A}$ , $di_s/dt = 9.3\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175^\circ\text{C}$ ), $V_{DD} = 600\text{ V}$ , $V_{GS} = -3\text{ V}$ , $t_{dead} = 200\text{ ns}$  | $T_{vj} = 25^\circ\text{C}$  | 1.3  |      | mJ            |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 125^\circ\text{C}$ | 3.8  |      |               |
|                                    |             |                                                                                                                                                                                  | $T_{vj} = 175^\circ\text{C}$ | 5.3  |      |               |

### 4 NTC-Thermistor

**Table 8** Characteristic values

| Parameter              | Symbol       | Note or test condition                                  | Values |      |      | Unit       |
|------------------------|--------------|---------------------------------------------------------|--------|------|------|------------|
|                        |              |                                                         | Min.   | Typ. | Max. |            |
| Rated resistance       | $R_{25}$     | $T_{NTC} = 25^\circ\text{C}$                            |        | 5    |      | k $\Omega$ |
| Deviation of $R_{100}$ | $\Delta R/R$ | $T_{NTC} = 100^\circ\text{C}$ , $R_{100} = 493\ \Omega$ | -5     |      | 5    | %          |

(table continues...)

**Table 8** (continued) Characteristic values

| Parameter         | Symbol       | Note or test condition                                       | Values |      |      | Unit |
|-------------------|--------------|--------------------------------------------------------------|--------|------|------|------|
|                   |              |                                                              | Min.   | Typ. | Max. |      |
| Power dissipation | $P_{25}$     | $T_{NTC} = 25\text{ °C}$                                     |        |      | 20   | mW   |
| B-value           | $B_{25/50}$  | $R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$  |        | 3375 |      | K    |
| B-value           | $B_{25/80}$  | $R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$  |        | 3411 |      | K    |
| B-value           | $B_{25/100}$ | $R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$ |        | 3433 |      | K    |

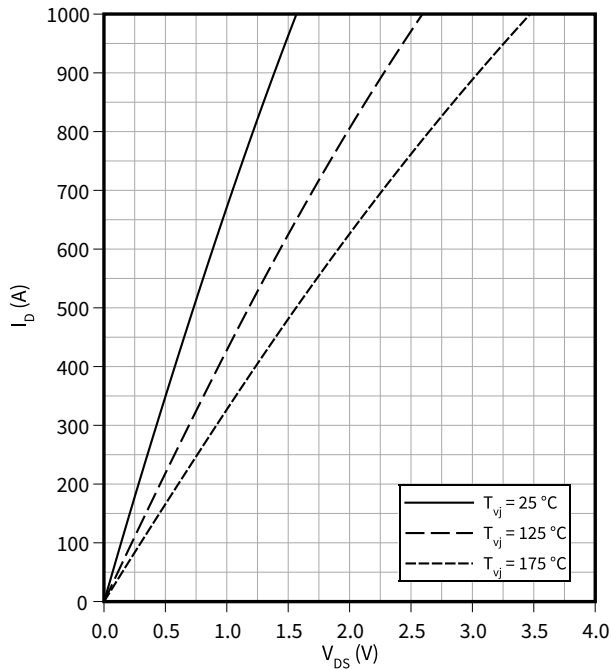
**Note:** For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4.

5 Characteristics diagrams

Output characteristic (typical), MOSFET, T1 / T2

$I_D = f(V_{DS})$

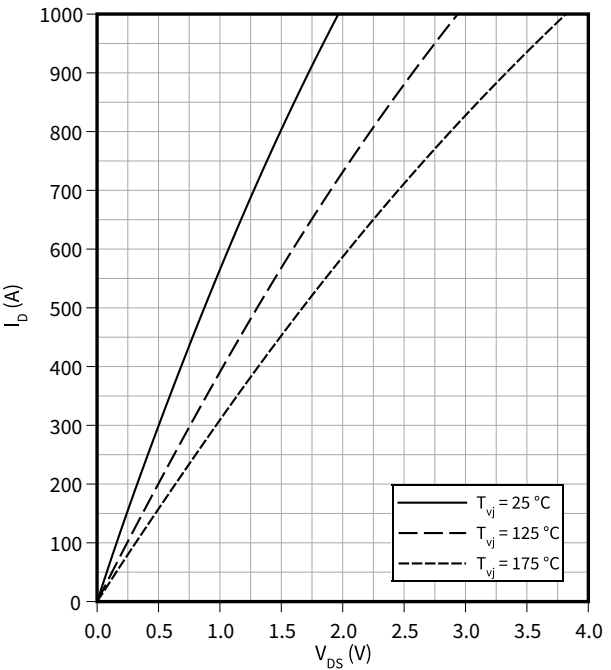
$V_{GS} = 18\text{ V}$



Output characteristic (typical), MOSFET, T1 / T2

$I_D = f(V_{DS})$

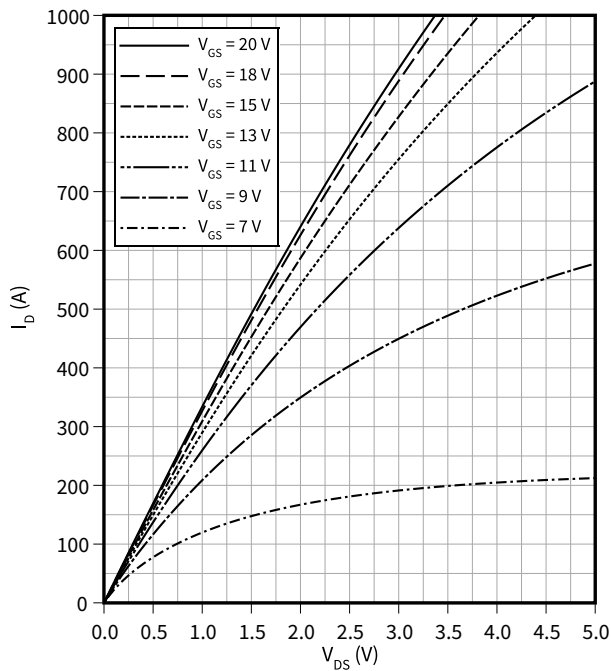
$V_{GS} = 15\text{ V}$



Output characteristic field (typical), MOSFET, T1 / T2

$I_D = f(V_{DS})$

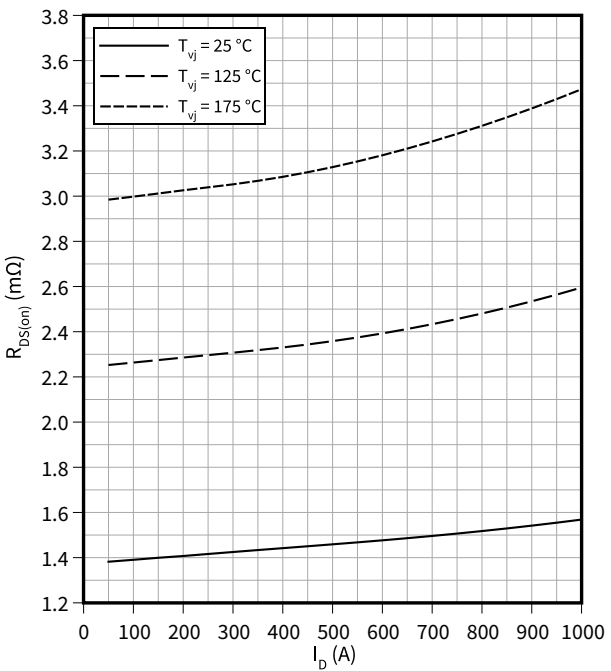
$T_{vj} = 175\text{ °C}$



Drain source on-resistance (typical), MOSFET, T1 / T2

$R_{DS(on)} = f(I_D)$

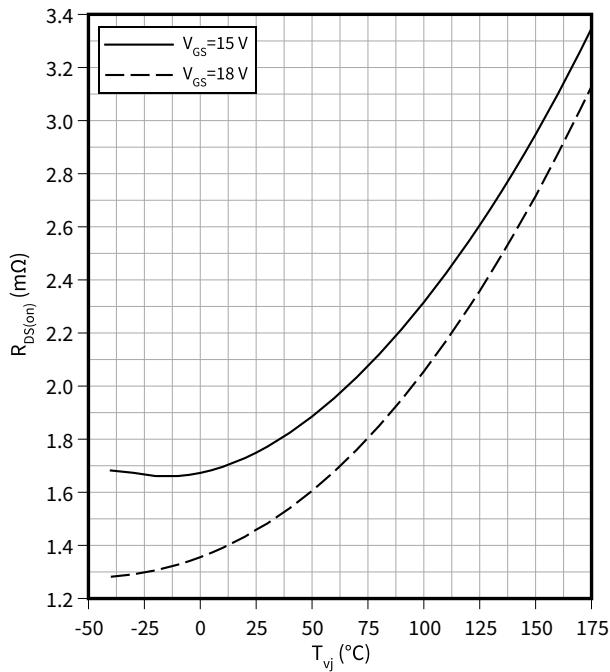
$V_{GS} = 18\text{ V}$



5 Characteristics diagrams

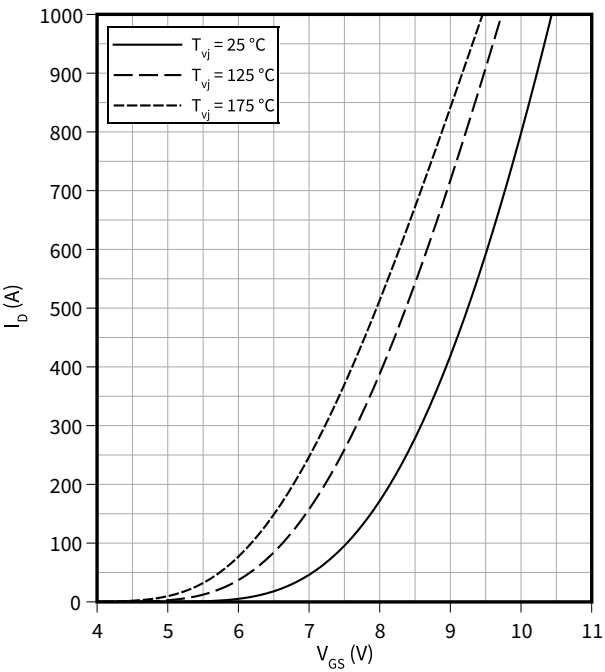
Drain source on-resistance (typical), MOSFET, T1 / T2

$R_{DS(on)} = f(T_{vj})$   
 $I_D = 500\text{ A}$



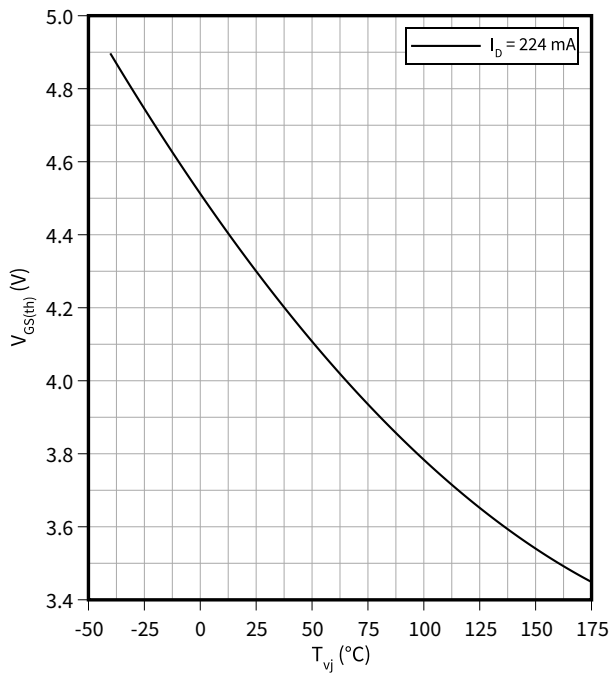
Transfer characteristic (typical), MOSFET, T1 / T2

$I_D = f(V_{GS})$   
 $V_{DS} = 20\text{ V}$



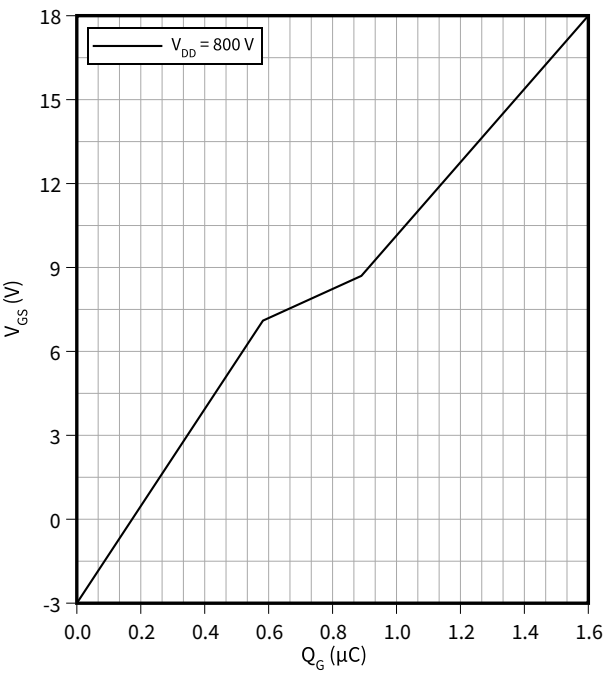
Gate-source threshold voltage (typical), MOSFET, T1 / T2

$V_{GS(th)} = f(T_{vj})$   
 $V_{GS} = V_{DS}$



Gate charge characteristic (typical), MOSFET, T1 / T2

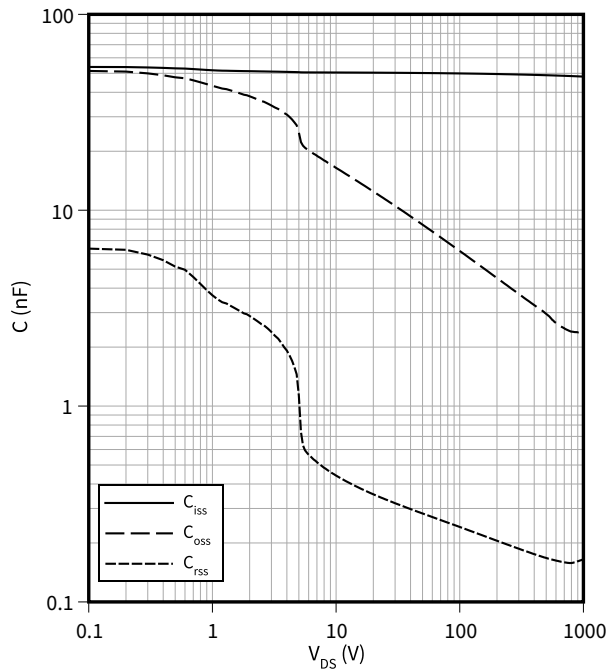
$V_{GS} = f(Q_G)$   
 $I_D = 500\text{ A}, T_{vj} = 25\text{ °C}$



5 Characteristics diagrams

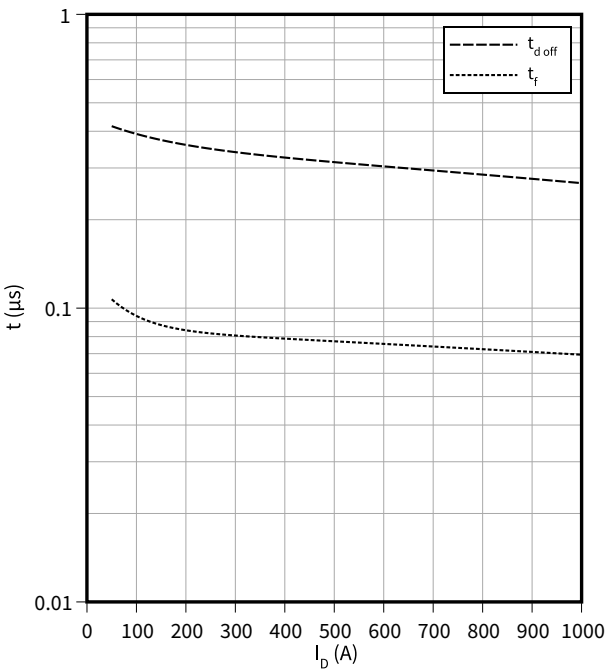
Capacity characteristic (typical), MOSFET, T1 / T2

$C = f(V_{DS})$   
 $T_{vj} = 25\text{ °C}, V_{GS} = 0\text{ V}, f = 100\text{ kHz}$



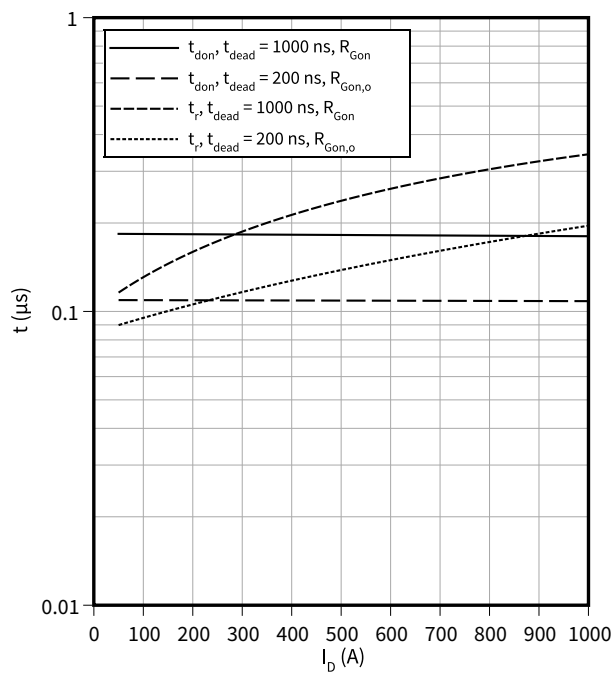
Switching times (typical), MOSFET, T1 / T2

$t = f(I_D)$   
 $R_{Goff} = 3.9\text{ }\Omega, V_{DD} = 600\text{ V}, T_{vj} = 175\text{ °C}, V_{GS} = -3/18\text{ V}$



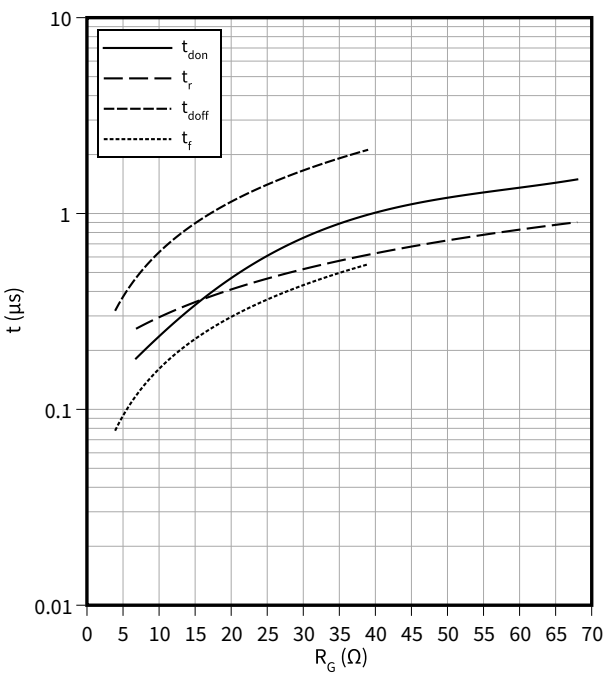
Switching times (typical), MOSFET, T1 / T2

$t = f(I_D)$   
 $V_{DD} = 600\text{ V}, R_{Gon} = 6.8\text{ }\Omega, R_{Gon,o} = 2.4\text{ }\Omega, T_{vj} = 175\text{ °C}, V_{GS} = -3/18\text{ V}$



Switching times (typical), MOSFET, T1 / T2

$t = f(R_G)$   
 $V_{DD} = 600\text{ V}, t_{dead} = 1000\text{ ns}, I_D = 500\text{ A}, T_{vj} = 175\text{ °C}, V_{GS} = -3/18\text{ V}$

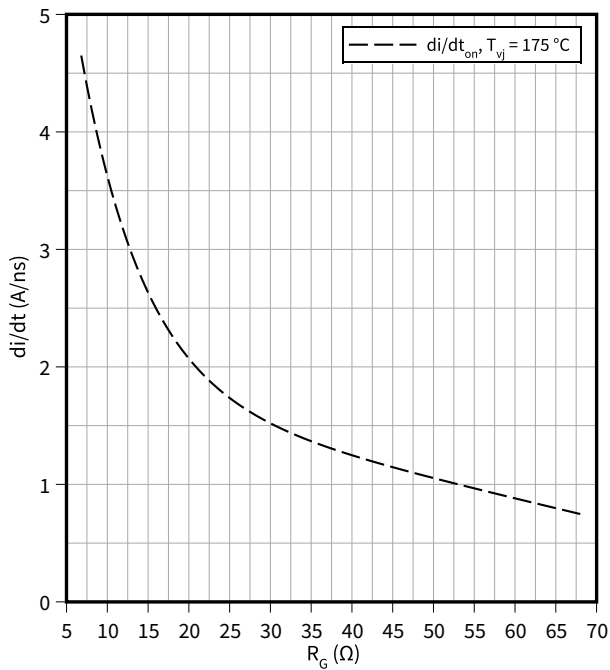


5 Characteristics diagrams

Current slope (typical), MOSFET, T1 / T2

$di/dt = f(R_G)$

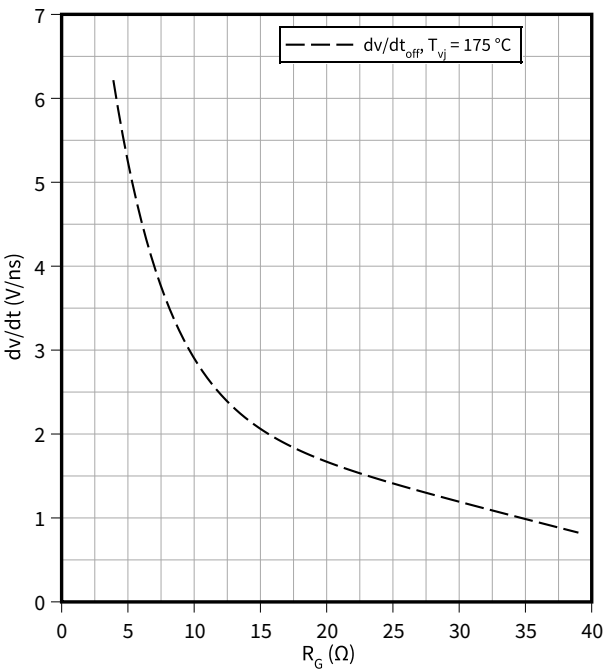
$V_{DD} = 600\text{ V}$ ,  $I_D = 500\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



Voltage slope (typical), MOSFET, T1 / T2

$dv/dt = f(R_G)$

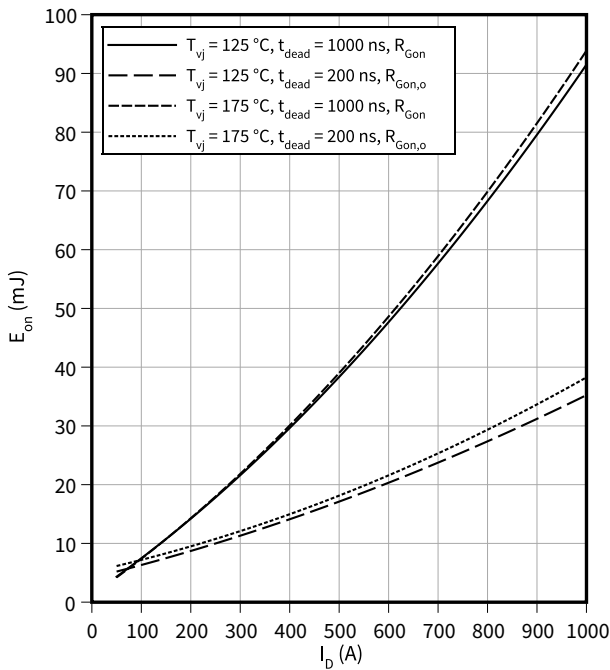
$V_{DD} = 600\text{ V}$ ,  $I_D = 500\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



Switching losses (typical), MOSFET, T1 / T2

$E_{on} = f(I_D)$

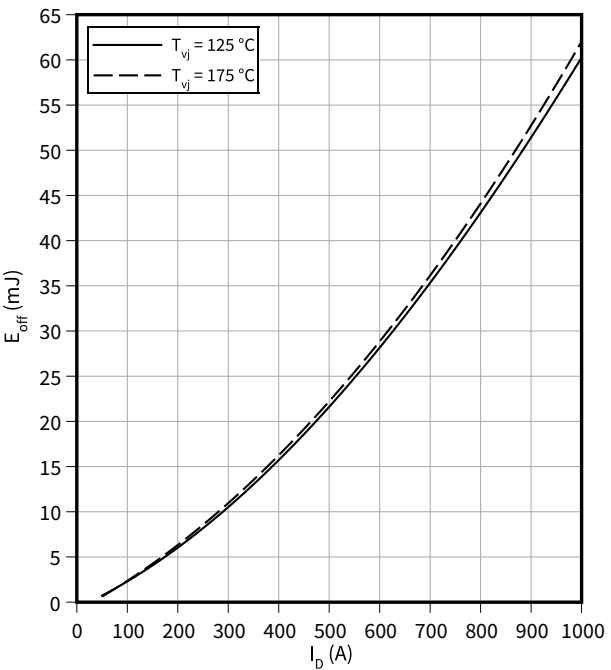
$V_{DD} = 600\text{ V}$ ,  $R_{Gon} = 6.8\text{ Ω}$ ,  $R_{Gon,o} = 2.4\text{ Ω}$ ,  $V_{GS} = -3/18\text{ V}$



Switching losses (typical), MOSFET, T1 / T2

$E_{off} = f(I_D)$

$R_{Goff} = 3.9\text{ Ω}$ ,  $V_{DD} = 600\text{ V}$ ,  $V_{GS} = -3/18\text{ V}$

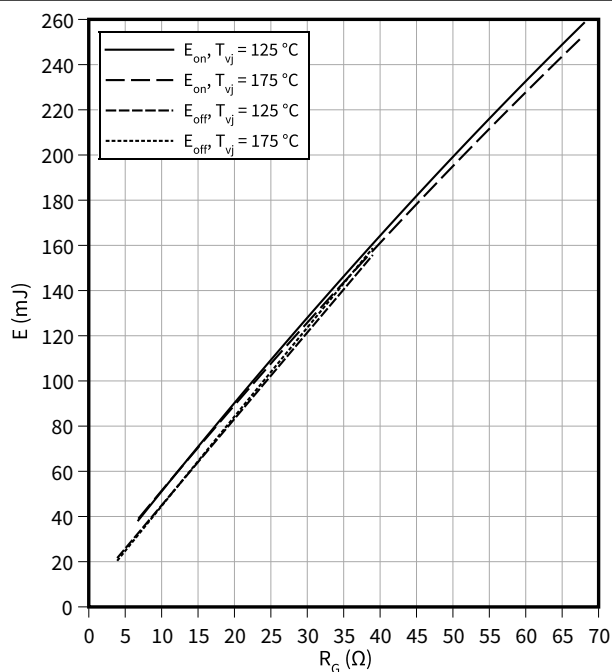


**5 Characteristics diagrams**

**Switching losses (typical), MOSFET, T1 / T2**

$$E = f(R_G)$$

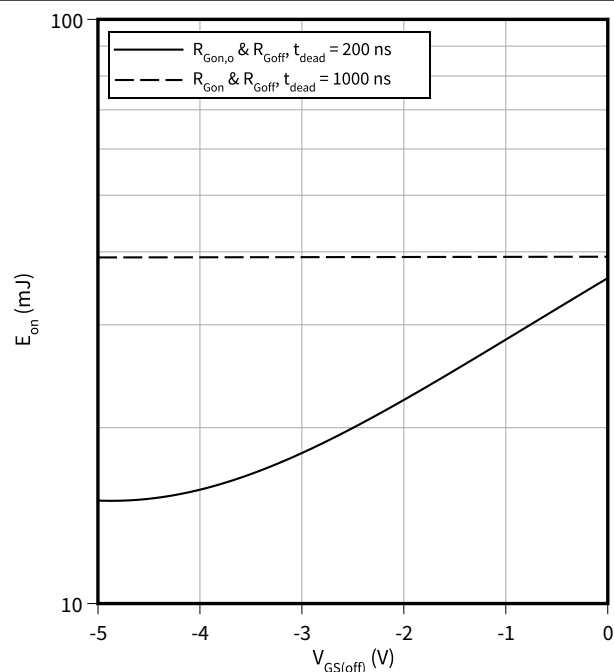
$V_{DD} = 600 \text{ V}$ ,  $t_{\text{dead}} = 1000 \text{ ns}$ ,  $I_D = 500 \text{ A}$ ,  $V_{GS} = -3/18 \text{ V}$



**Switching losses (typical), MOSFET, T1 / T2**

$$E_{\text{on}} = f(V_{GS(\text{off})})$$

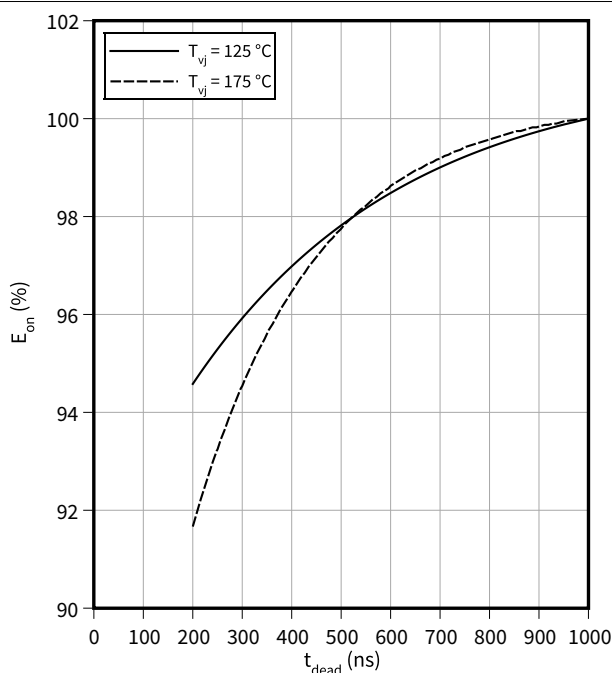
$R_{\text{Goff}} = 3.9 \Omega$ ,  $V_{DD} = 600 \text{ V}$ ,  $R_{\text{Gon}} = 6.8 \Omega$ ,  $V_{GS(\text{on})} = 18 \text{ V}$ ,  $I_D = 500 \text{ A}$ ,  $R_{\text{Gon},0} = 2.4 \Omega$ ,  $T_{vj} = 175 \text{ °C}$



**Switching losses (typical), MOSFET, T1 / T2**

$$E_{\text{on}} = f(t_{\text{dead}})$$

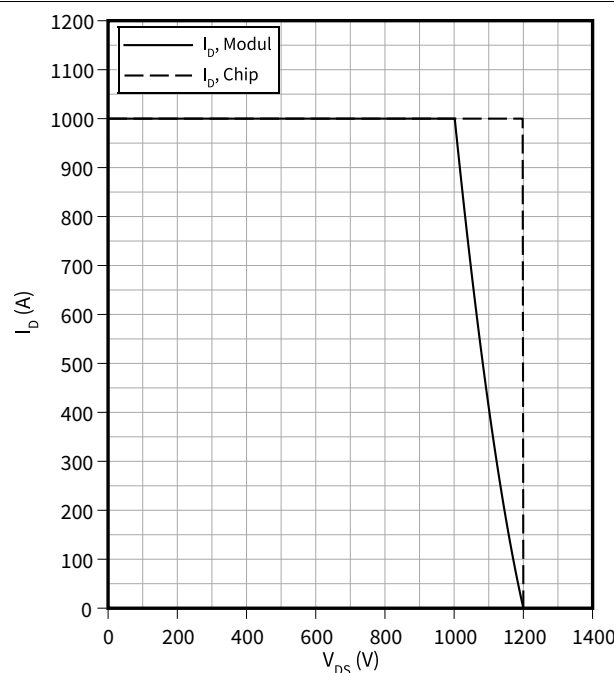
$R_{\text{Gon}} = 6.8 \Omega$ ,  $I_D = 500 \text{ A}$ ,  $V_{DD} = 600 \text{ V}$ ,  $V_{GS} = -3/18 \text{ V}$



**Reverse bias safe operating area (RBSOA), MOSFET, T1 / T2**

$$I_D = f(V_{DS})$$

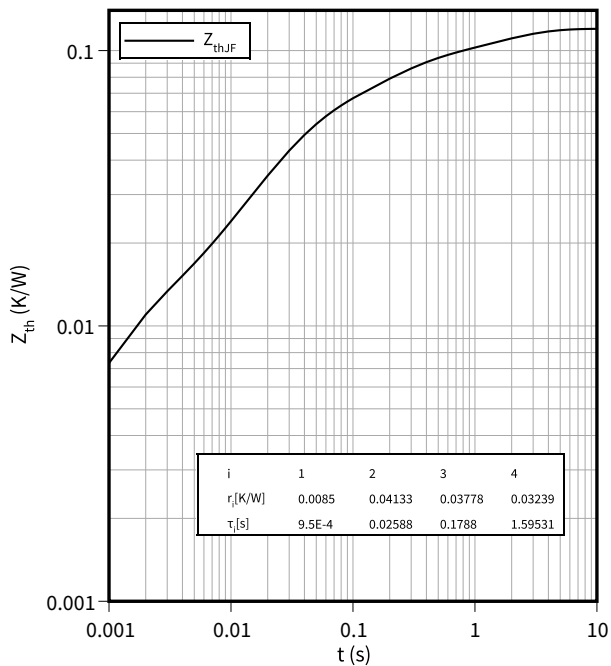
$R_{\text{Goff}} = 3.9 \Omega$ ,  $T_{vj} = 175 \text{ °C}$ ,  $V_{GS} = -3/18 \text{ V}$



5 Characteristics diagrams

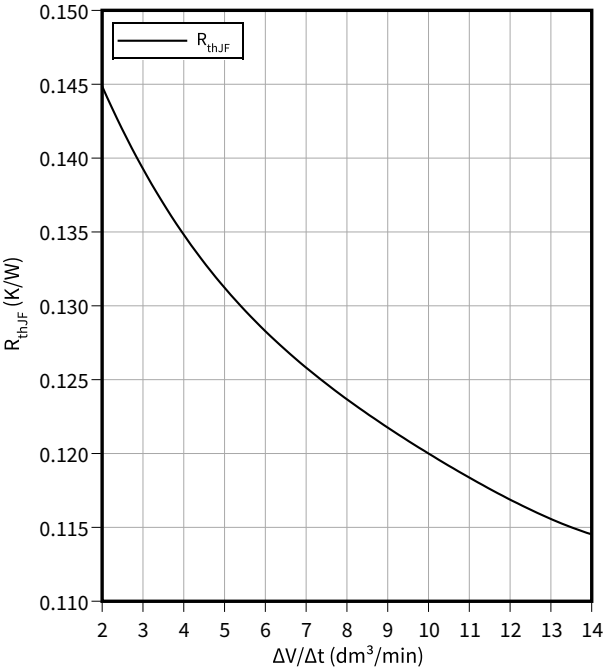
Transient thermal impedance, MOSFET, T1 / T2

$Z_{th} = f(t)$



Thermal impedance, MOSFET, T1 / T2

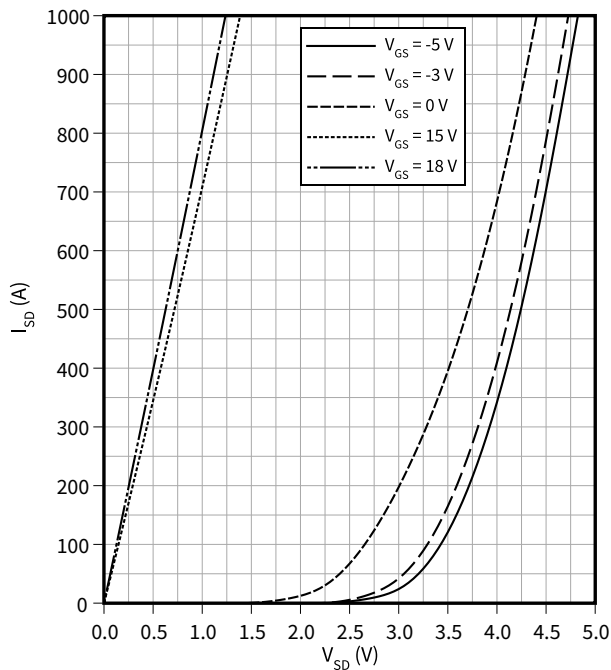
$R_{thJF} = f(\Delta V/\Delta t)$



Forward characteristic body diode (typical), MOSFET, T1 / T2

$I_{SD} = f(V_{SD})$

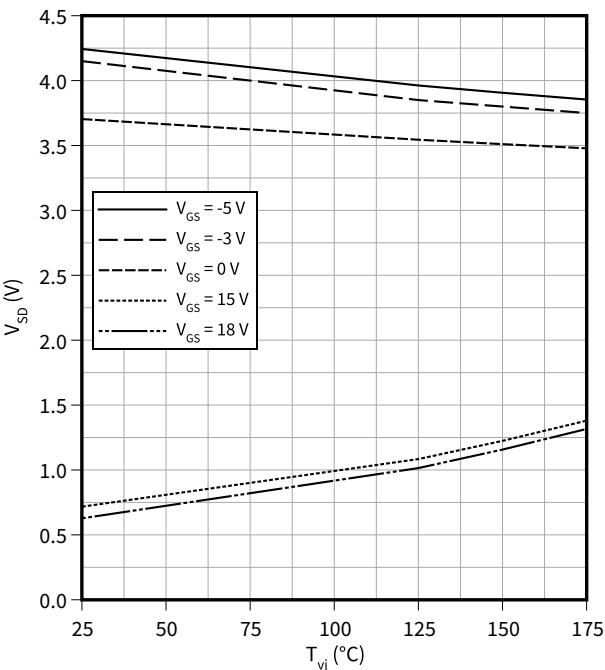
$T_{vj} = 25\text{ }^{\circ}\text{C}$



Forward voltage of body diode (typical), MOSFET, T1 / T2

$V_{SD} = f(T_{vj})$

$I_{SD} = 500\text{ A}$

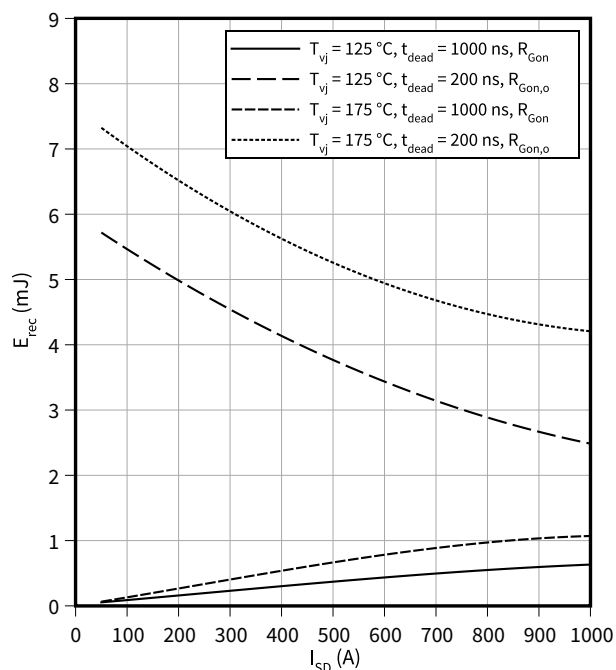


**5 Characteristics diagrams**

**Switching losses body diode (typical), MOSFET, T1 / T2**

$$E_{\text{rec}} = f(I_{\text{SD}})$$

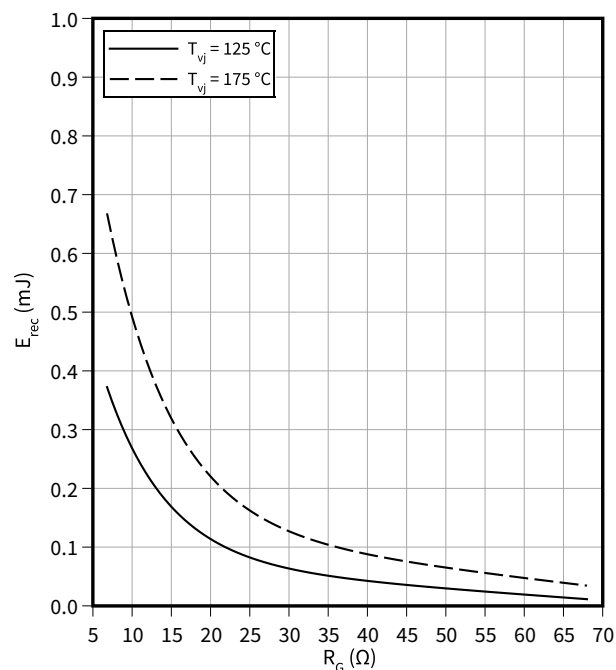
$R_{\text{Gon}} = 6.8 \, \Omega$ ,  $R_{\text{Gon,o}} = 2.4 \, \Omega$ ,  $V_{\text{DD}} = 600 \, \text{V}$



**Switching losses body diode (typical), MOSFET, T1 / T2**

$$E_{\text{rec}} = f(R_{\text{G}})$$

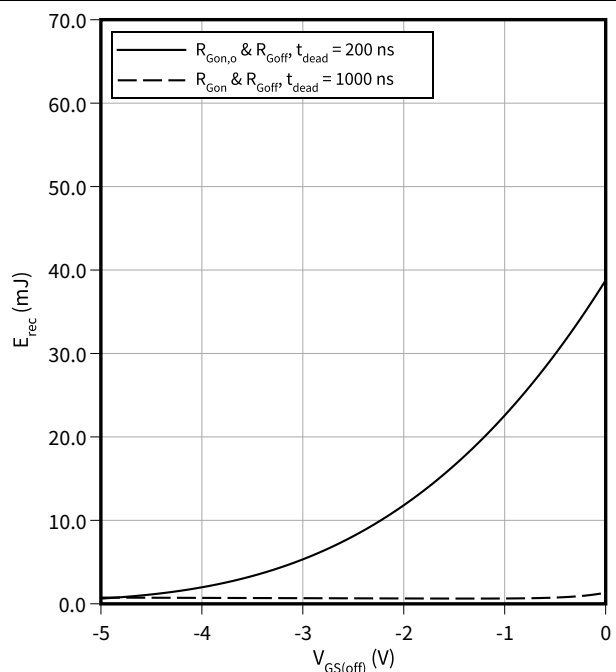
$t_{\text{dead}} = 1000 \, \text{ns}$ ,  $I_{\text{SD}} = 500 \, \text{A}$ ,  $V_{\text{DD}} = 600 \, \text{V}$



**Switching losses body diode (typical), MOSFET, T1 / T2**

$$E_{\text{rec}} = f(V_{\text{GS(off)}})$$

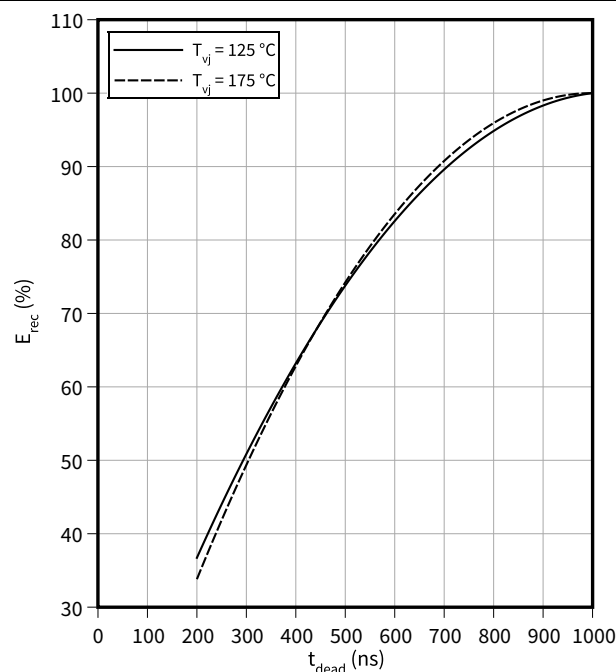
$R_{\text{Goff}} = 3.9 \, \Omega$ ,  $R_{\text{Gon}} = 6.8 \, \Omega$ ,  $V_{\text{GS(on)}} = 18 \, \text{V}$ ,  $I_{\text{SD}} = 500 \, \text{A}$ ,  $R_{\text{Gon,o}} = 2.4 \, \Omega$ ,  $V_{\text{DD}} = 600 \, \text{V}$ ,  $T_{\text{vj}} = 175 \, ^\circ\text{C}$



**Switching losses body diode (typical), MOSFET, T1 / T2**

$$E_{\text{rec}} = f(t_{\text{dead}})$$

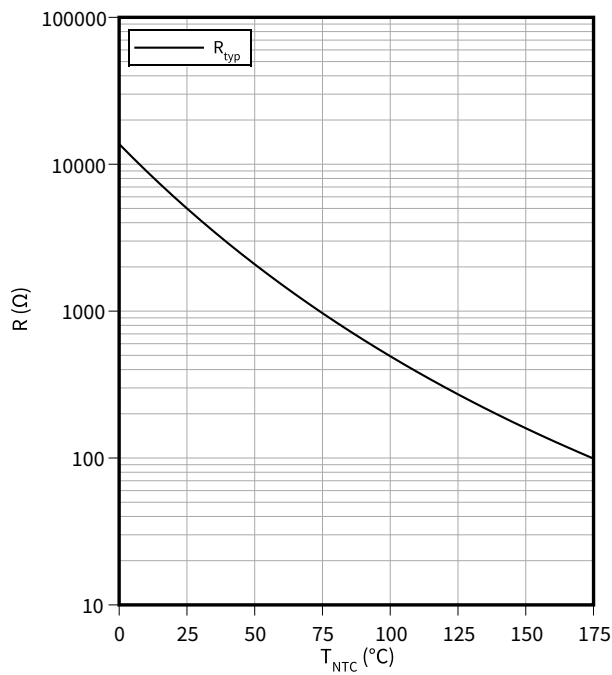
$R_{\text{Gon}} = 6.8 \, \Omega$ ,  $I_{\text{D}} = 500 \, \text{A}$ ,  $V_{\text{DD}} = 600 \, \text{V}$ ,  $V_{\text{GS}} = -3/18 \, \text{V}$



5 Characteristics diagrams

Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



6 Circuit diagram

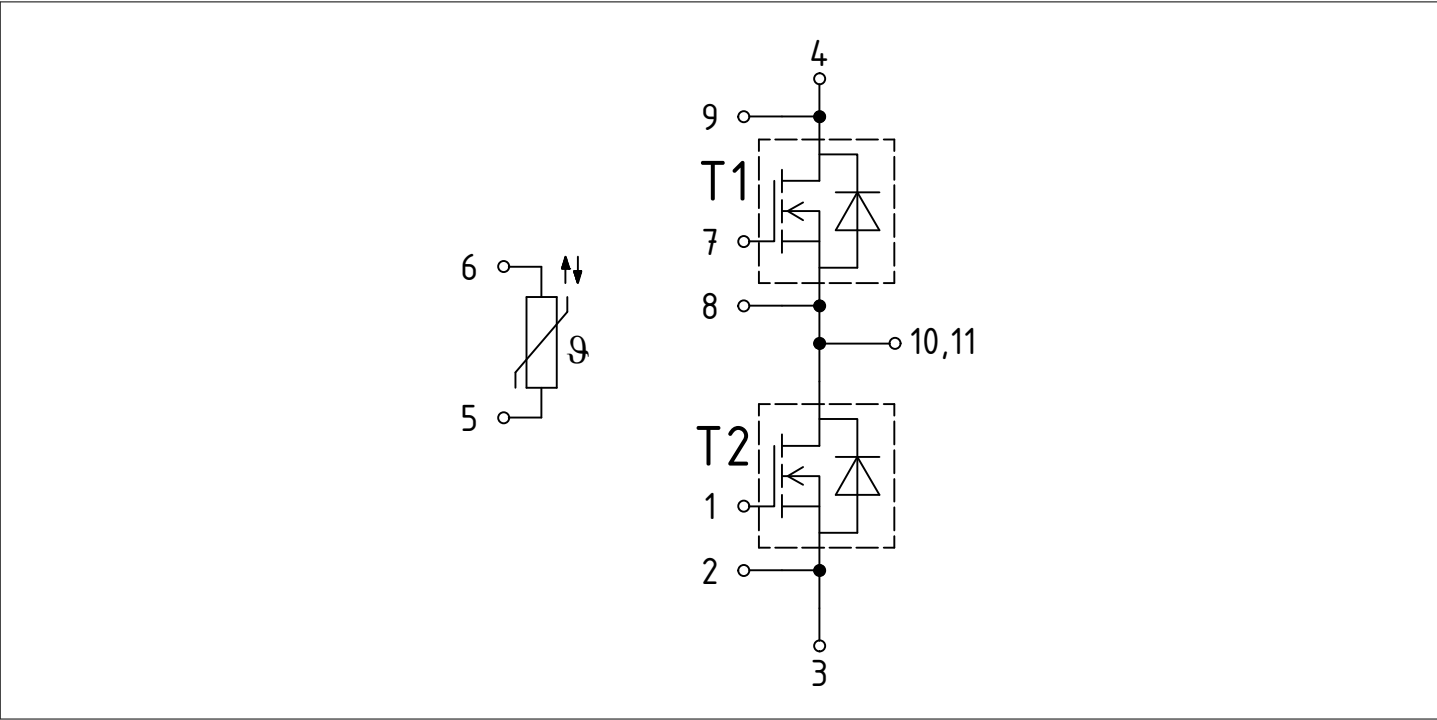


Figure 1

## 7 Package outlines

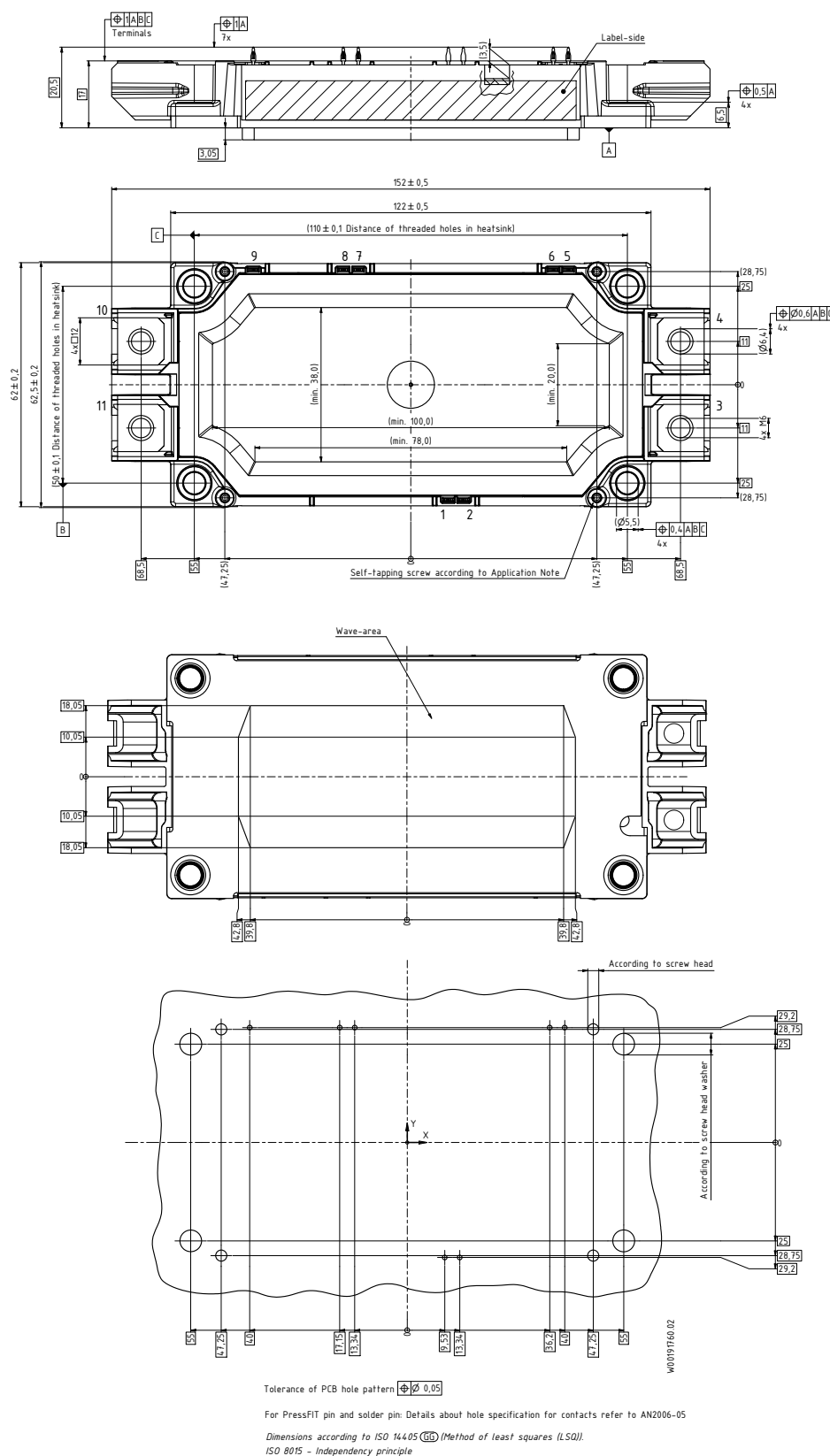


Figure 2

8 Module label code

| Module label code |                                                                                                                                                                                                                                           |         |                 |
|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|
| Code format       | Data Matrix                                                                                                                                                                                                                               |         | Barcode Code128 |
| Encoding          | ASCII text                                                                                                                                                                                                                                |         | Code Set A      |
| Symbol size       | 16x16                                                                                                                                                                                                                                     |         | 23 digits       |
| Standard          | IEC24720 and IEC16022                                                                                                                                                                                                                     |         | IEC8859-1       |
| Code content      | Content                                                                                                                                                                                                                                   | Digit   | Example         |
|                   | Module serial number                                                                                                                                                                                                                      | 1 – 5   | 71549           |
|                   | Module material number                                                                                                                                                                                                                    | 6 - 11  | 142846          |
|                   | Production order number                                                                                                                                                                                                                   | 12 - 19 | 55054991        |
|                   | Date code (production year)                                                                                                                                                                                                               | 20 – 21 | 15              |
|                   | Date code (production week)                                                                                                                                                                                                               | 22 – 23 | 30              |
| Example           | <div><div>7154914284655054991153071549142846550549911530</div></div> |         |                 |

Figure 3



Revision history

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 0.10              | 2024-12-02      | Preliminary datasheet  |
| 1.00              | 2025-03-06      | Final datasheet        |
| 1.10              | 2025-07-25      | Final datasheet        |

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**Edition 2025-07-25**

**Published by**

**Infineon Technologies AG**  
**81726 Munich, Germany**

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**IFX-ABM306-003**

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